Specifications

		High-Speed Compact Modular Mounter RX-8
Board size		50×50∼510mm ^{*¹ *²} ×450mm
Component height		3mm
Component size		0201 ^{*3} ∼□5mm
Placement speed (optimum)	Chip	100,000CPH
Placement accuracy		\pm 0.04mm (Cpk \geq 1)
Feeder capacity		Up to 56 * ⁴
Power supply		3-phase AC200V, 220V - 430V * ⁵
Apparent power		2.1kVA
Operating air pressure		0.5±0.05MPa
Air consumption (standard)		20L/ min ANR (during normal operation)
Machine dimensions (W×D×H)*6		998mm×1,895mm×1,530mm
Mass (approximately)		1,810 kg (with fixed bank) / 1,760 kg (with bank changing)

- *1 BOC, Bad Mark, and 2D barcode can be read only if board length is from 50mm to 350mm
- *2 In long board mode (two boards can be produced simultaneously up to 420mm long).
- *3 Please contact JUKI for details.
- *4 When using RF08AS
- *5 220V 430V requires a separate transformer
- *6 Depth D does not include the monitor, and height H does not include the signal light when the conveyor height is 900 mm.

Options

Conveyor system	Support pin / Support plate
Other	Dedicated nozzle / Spare nozzle cartridge / Connecting cable / Earth leakage circuit breaker / Work lighting
Available Feeders and Accessories	Feeder bank exchange trolley / Electric tape feeder / Fixed (RF) bank / Feeder setup station Tape splicing jig / Feeder adjustment jig / External power supply for electric feeder banks

Software

JaNets*	User definition / Facility definition / Component DB / Creating production programs / Line optimization / Line monitoring / CAD conversion / Cluster optimization
IFS-NX	Prevents loading parts in the wrong location / Tracks remaining quantity of parts/ Feeder search / External setup verification / Random feeder setup
Virus measurement software	White list (standard)

^{*} Option

■JUKI Specifications and appearance may be changed without notice.

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JUKI CORPORATION HEAD OFFICE

High-Speed Compact Modular Mounter







Highest placement rates per square meter (sq foot) Achieves high-speed placements of up to 100,000 CPH



SOFTWARE



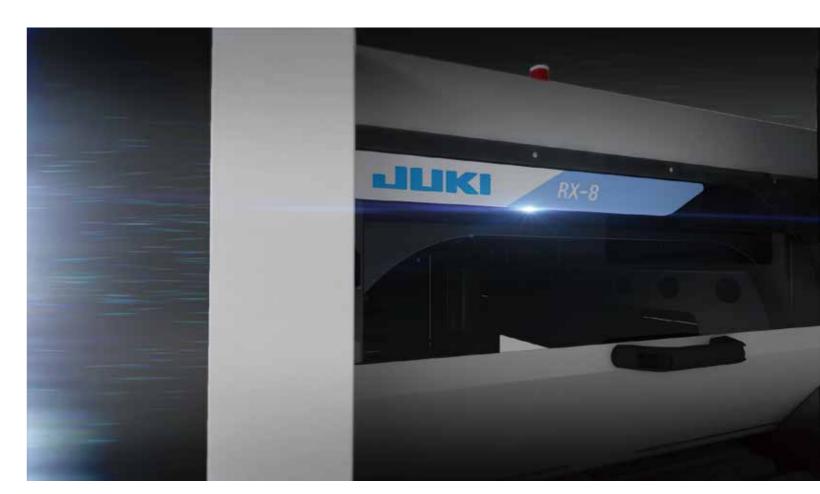












Productivity Connected Quality

Highest placement rates per square meter (sq foot)*2

Achieves high-speed placements of up to 100,000 CPH*1

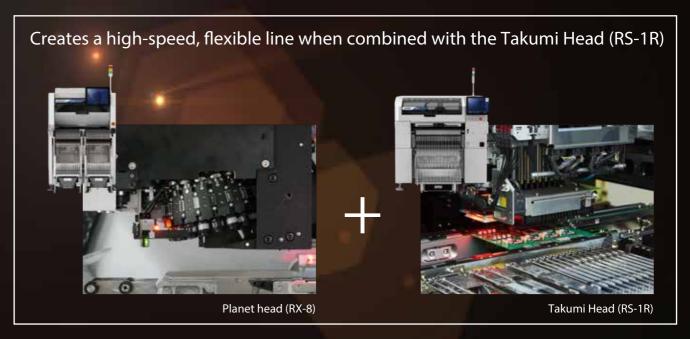
Productivity Connected Quality



Feature 1 High-speed placements of up to 100,000 CPH*1, best-in-class placement rate per square meter (sq ft)*2

Feature 2 Integrates seamlessly with the production environment

Feature 3 Achieves high quality production





High-speed placements of up to 100,000 CPH.*1 Best-in-class placement rate per square meter (sq ft)*2

New P20 placement head achieves speeds of up to 100,000CPH. At only 998mm wide, the RX-8 provides exceptional productivity in a compact footprint. Best in class placement per square meter (square foot)

* 1 Optimum conditions *2 Market survey data

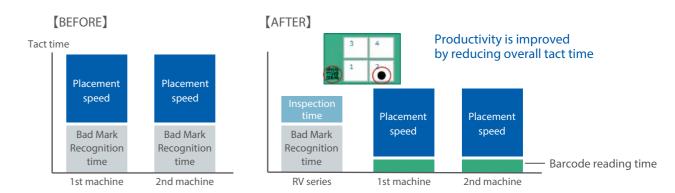


Integrates seamlessly with the production enviroment

Efficient production is made possible via upstream data sharing to support bad mark propagation, component supply management while showing real-time status of the production line.

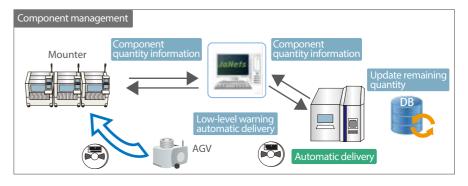
Communicates and shares information with other equipment

Bad mark information of the circuit detected by the inspection machine or a machine upstream of the line can be propagated to the RX-8 in order to reduce the bad mark recognition timed and improve productivity.



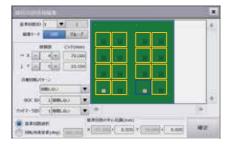
Component Management with Auto replenishment

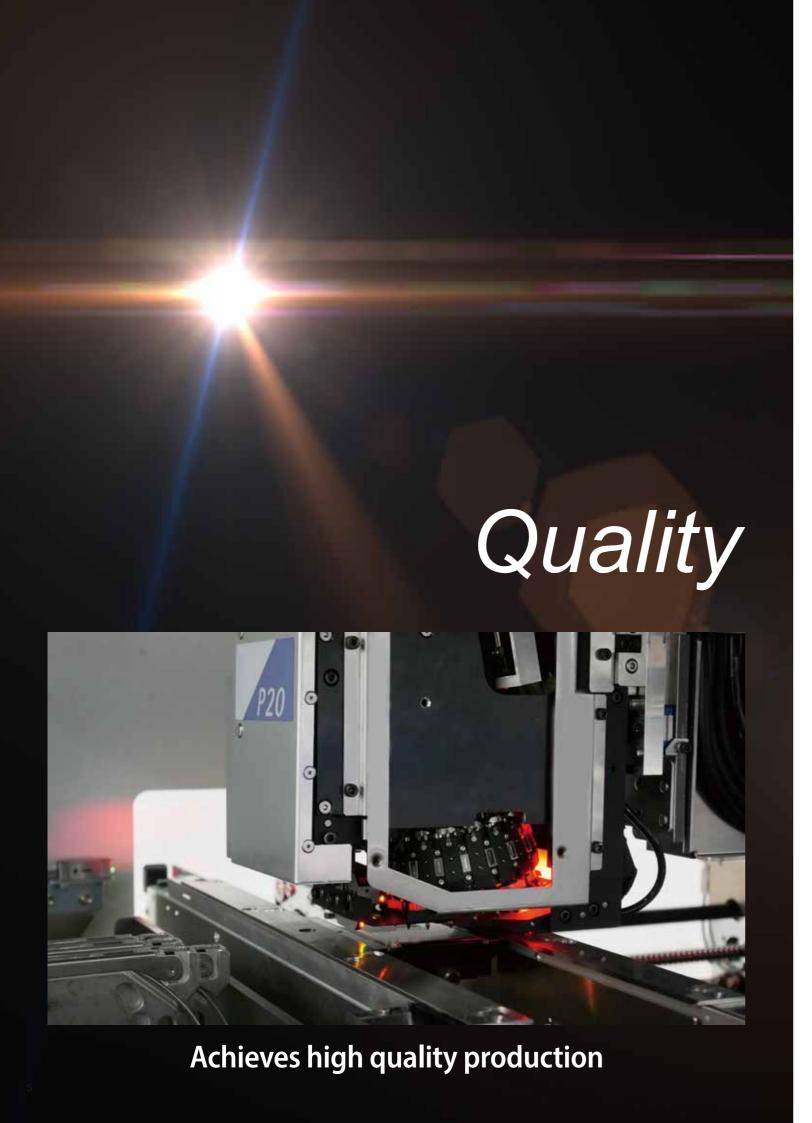
Top production efficiency is achieved by continuous monitoring of component consumption and communication with the Automated Component Storage and Transport System. When the placement system detects a low-level warning, it automatically communicates that information to the storage system, which immediately pulls an additional reel of that component, loads it on an AIV to transport the reel to the line to arrive before the existing reel has run out. This eliminates downtime during production due to component run out.



It is very simple to generate PCB programming data

Using visual aids of the board layout makes programming intuitive and simple





Trace Monitor tracks quality throughout the production process

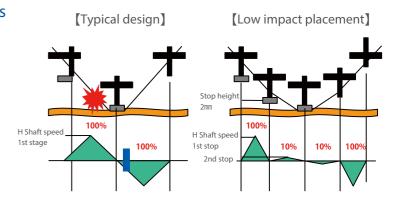
Trace Monitor provides real time status of the placement head during production. It tracks mis-picks, recognition errors and records which feeders and nozzles those errors came from. A dashboard displays all the key performance indicators making it easy to view the production efficiency and what is needed to improve the process.



Trace Monitor dashboard

Low impact placement for flexible circuits

Low Impact feature allows separately adjusting the down and up speed of the nozzle during placement. This minimizes the load on the part and on the board during placement. This is optimal for placing very small parts that require a lot of accuracy.



The P20 high-precision planet head is ideal for high speed picking and placing from a single reel.

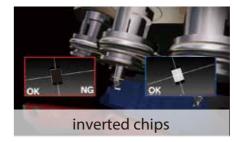
The P20 is designed for placement of ultra-small chips and small IC's. It is ideal for high-density and high-accuracy placements of LED edge lights.

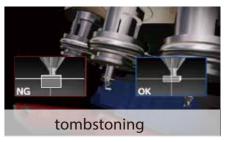


Introducing the New P20 head

State-of-the-art centering and inspection vision system

The vision system detects presence and absensce, inverted chips, and tombstoning. It also automatically corrects the pick position of every part, increasing the pick rate. This system makes it ideal for placing very small parts.



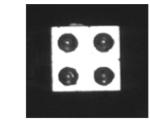


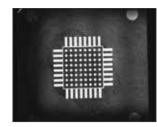
New high accuracy camera for inspection and centering

New coaxial lighting technology gets clearer images and better, more accurate inspection data.



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0402 chip (metric)

0603 chip (metric)

Small BGA

Glass Jig